

Certificate TW01/00039

The management system of

Kinsus Interconnect Technology Corp.

SGS

No. 1245 & 1245-1, Zhonghua Rd., Xinwu Dist., Taoyuan City 327, Taiwan, R.O.C.

has been assessed and certified as meeting the requirements of

ISO 14001:2015

For the following activities

The manufacture and sale of printed circuit board, BGA substrate, flexible printed circuit board, flexible substrate for chip packaging and ABF carrier board.

This certificate is valid from 10 October 2023 until 19 November 2024 and remains valid subject to satisfactory surveillance audits.

Issue 12. Certified since 11 December 2001

Certified activities performed by additional sites are listed on subsequent pages.

Jonathan H. Hall

Authorised by

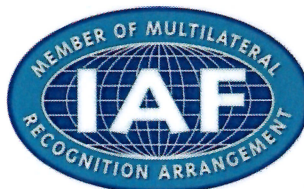
Jonathan Hall

Global Head - Certification Services

SGS United Kingdom Ltd

Rossmore Business Park, Ellesmere Port, Cheshire, CH65 3EN, UK

t +44 (0)151 350-6666 - www.sgs.com



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Kinsus Interconnect Technology Corp.

ISO 14001:2015

Issue 12

Sites

Kinsus Interconnect Technology Corp.
No. 1245 & 1245-1, Zhonghua Rd., Xinwu Dist., Taoyuan City 327, Taiwan, R.O.C.

The manufacture and sale of printed circuit board, BGA substrate, flexible printed circuit board, flexible substrate for chip packaging and ABF carrier board.

Kinsus Interconnect Technology Corp. & Second Plant
No. 1245 & 1245-1, Zhonghua Rd., Xinwu Dist., Taoyuan City 327, Taiwan, R.O.C.

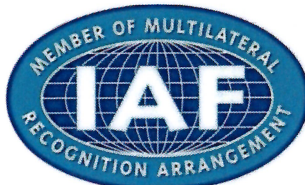
The manufacture and sale of printed circuit board, BGA substrate, flexible printed circuit board, and flexible substrate for chip packaging.

Kinsus Interconnect Technology Corp. Tsing-Hua First Plant & Third Plant
No.810 & 810-1, Zhonghua Rd., Xinwu Dist., Taoyuan City 327, Taiwan, R.O.C.

The manufacture of printed circuit board, BGA substrate, flexible printed circuit board, and flexible substrate for chip packaging.

Kinsus Interconnect Technology Corp. Xing-Feng First Plant
No. 526 Sec. 2, Jianxing Rd., Xinfeng Township Hsinchu County 304, Taiwan, R.O.C.

The manufacture of printed circuit board, BGA substrate, flexible printed circuit board, and flexible substrate for chip packaging.



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Certificate TW01/00039, continued



Kinsus Interconnect Technology Corp.

ISO 14001:2015

Kinsus Interconnect Technology Corp. Xing-Feng Second Plant
No. 12, Ln. 468, Sec. 2, Jianxing Rd., Xinfeng Township, Hsinchu County 304, Taiwan, R.O.C.

The manufacture of printed circuit board, BGA substrate, flexible printed circuit board, and flexible substrate for chip packaging.

Kinsus Interconnect Technology Corp. You-Shi Plant
No. 566-1、580, Gaoshi Rd., Yangmei Dist., Taoyuan City 326, Taiwan, R.O.C.

The manufacture of ABF carrier board.



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